



Product Change Notification

Change Notification #: 115066 - 00
Change Title: Intel® Server Board S2600KPFR
PCN 115066-00
Product Design, Product Material
Replacement of components listed under
RoHS exemption 7c-I, Updated
BIOS/ME/BMC/FRUSDR Firmware and
Add a pull-up resistor on motherboards
Date of Publication: November 04, 2016

Key Characteristics of the Change:

Product Design, Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	Nov 21, 2016
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server Board S2600KPFR

1. Intel is replacing components containing substances listed under EU RoHS exemption 7c-I with exemption-free components. All new components are identical in form factor and function to the replaced ones.
2. Intel is implementing the new System Firmware installed at the Factory on the Intel® Server Board S2600KPFR:
 - a. Update the BIOS from revision R01.01.0014 to revision R01.01.0016.
 - b. Update the Manageability Engine (ME) firmware from revision 03.01.03.005 to revision 03.01.03.021.
 - c. Update the Integrated Baseboard Management Controller (BMC) firmware from revision 1.39.9375 to revision 01.43.9685.
 - d. Update the FRUSDR from revision 1.13 to revision 1.14

The system software update package, including the release notes for each, is available for download from <http://www.intel.com/support>. Please refer to the software release notes for a list of changes.

3. Intel is implementing the following changes on the Intel® Server Board S2600KPFR:

Place a 200.00k ohms, 1.00%, 1/16W resistor on motherboard in location R4N25 to prevent USB over current events in Linux logs when building the systems without any of Intel® Bridge Board FHWKTPBGB, AHWKPTP12GBGB or AHWKPTP12GBGBR5

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customers perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <http://www.intel.com/support>.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
BBS2600KPFR	943790	H37995-014	G93685-361	H37995-015	G93685-371

PCN Revision History:

Date of Revision:
November 4, 2016

Revision Number:
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Reason:
Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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